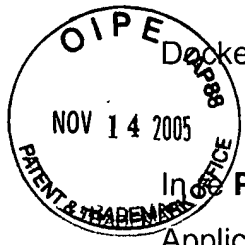


AP/2FW



Docket No. TIP484US

TI-36211

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In **PATENT** application of:

Applicant: Rajesh Tiwari et al.

Application No.: 10/663,948

For: DUAL DEPTH TRENCH TERMINATION METHOD FOR
IMPROVING CU-BASED INTERCONNECT INTEGRITY

Filing Date: September 16, 2003

Examiner: Phat X. CAO

Art Unit: 2814

REPLY TO OFFICE ACTION DATED SEPTEMBER 9, 2005

Mail Stop AF
Assistant Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

Favorable reconsideration of the above-identified application is respectfully
requested in view of the following amendments and remarks.